Qualcomm

RF360
Europe GmbH

SAW components

SAW filter
GPS + COMPASS + GLONASS

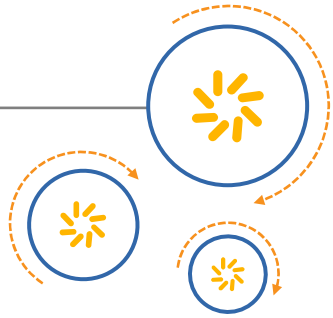
Series/type:	B8813
Ordering code:	B39162B8813P810
Date:	August 24, 2017
Version:	2.3

RF360 products mentioned within this document are products of RF360 Europe GmbH and other subsidiaries of RF360 Holdings Singapore Pte. Ltd. (collectively, the “RF360 Subsidiaries”).

RF360 Europe GmbH, Anzinger Str. 13, München, Germany

RF360 Europe GmbH

A Qualcomm – TDK Joint Venture



SAW components

SAW filter

GPS + COMPASS + GLONASS

Series/type:	B8813
Ordering code:	B39162B8813P810
Date:	August 24, 2017
Version:	2.3

RF360 products mentioned within this document are offered by RF360 Europe GmbH and other subsidiaries of RF360 Holdings Singapore Pte. Ltd. (collectively, the “RF360 Subsidiaries”).

RF360 Holdings Singapore Pte. Ltd. is a joint venture of Qualcomm Global Trading Pte. Ltd. and EPCOS AG.

RF360 Europe GmbH, Anzinger Str. 13, München, Germany

Table of contents

1 Application

- Low-loss GPS + COMPASS + GLONASS filter
- Simultaneous usage of GPS, COMPASS and GLONASS bands
- Usable passbands: 2.0 MHz for GPS, 4.092 MHz for COMPASS and 8.34 MHz for GLONASS
- Very low insertion attenuation
- High out of band selectivity
- Filter impedance 50 Ω
- Unbalanced to unbalanced operation
- No matching network required for operation at 50 Ω

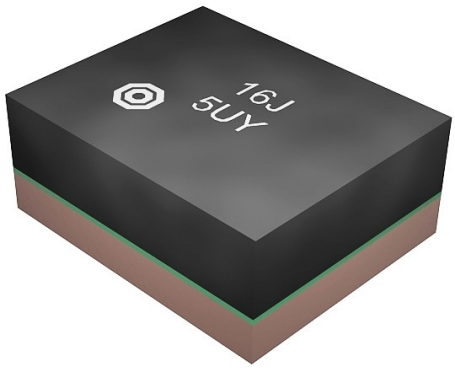


Figure 1: Picture of component with example of product marking.

2 Features

- Package size 1.1 mm × 0.9 mm
- Package height 0.45 mm (max.)
- Approximate weight 0.0012 g
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au-plated terminals
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level 3 (MSL3)

3 Package

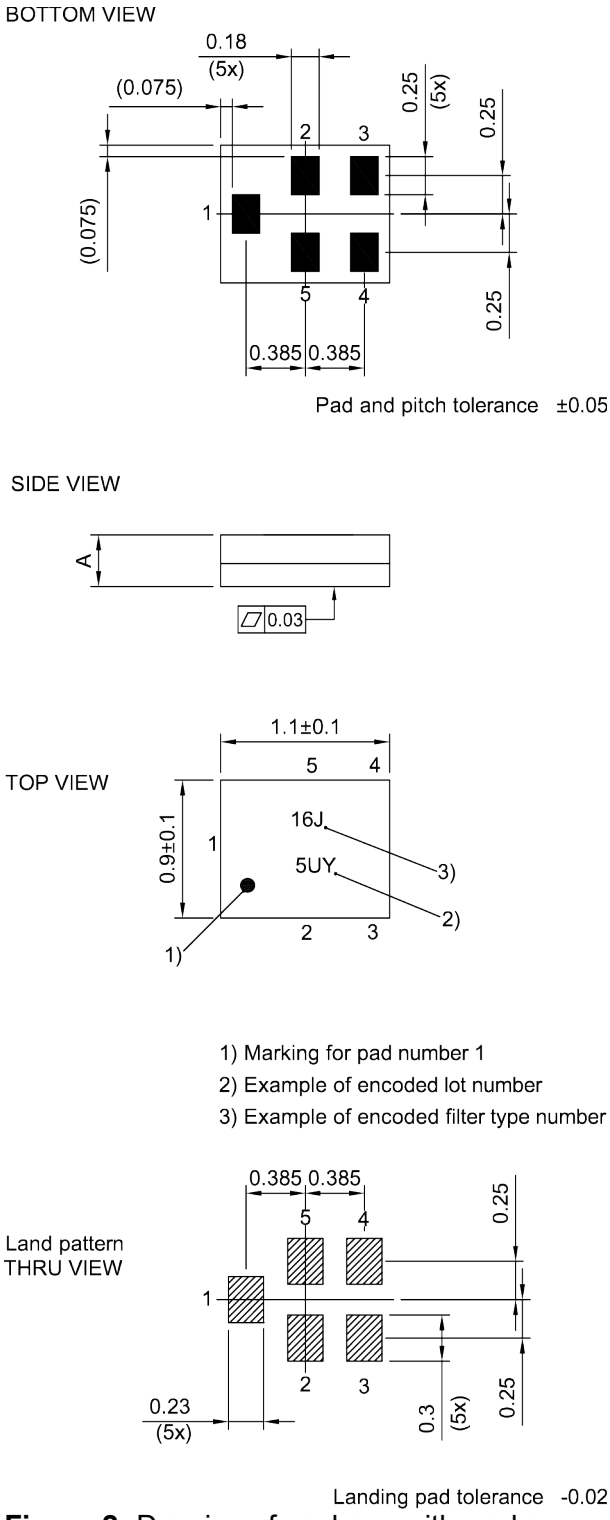


Figure 2: Drawing of package with package height A = 0.45 mm (max.). See Sec. Package information (p. 18).

4 Pin configuration

- 1 Input
- 4 Output
- 2, 3, 5 Ground

5 Matching circuit

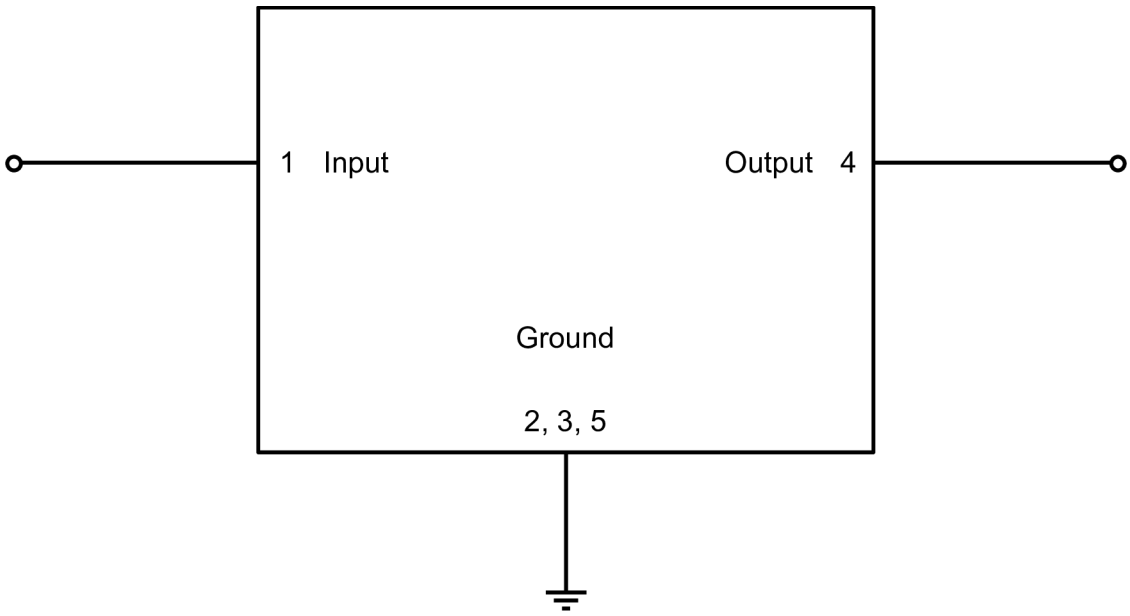


Figure 3: Schematic of matching circuit. No external matching components required.

6 Characteristics

Temperature range for specification T_{SPEC} = −30 °C ... +85 °C
Input terminating impedance Z_{IN} = 50 Ω
Output terminating impedance Z_{OUT} = 50 Ω

Characteristics			min. for T_{SPEC}	typ. @ +25 °C	max. for T_{SPEC}	
Center frequency	f_C		—	1582.47	—	MHz
Maximum insertion attenuation	α_{max}					
	1559.052... 1563.144	MHz	—	1.0	1.9	dB
	1573.42... 1575.50	MHz	—	0.85	1.4	dB
	1574.42... 1576.42	MHz	—	0.85	1.4	dB
	1597.55... 1605.89	MHz	—	1.2	1.9	dB
Maximum VSWR	$VSWR_{max}$					
@ input port	1559.052... 1563.144	MHz	—	1.5	1.9	
	1573.42... 1575.50	MHz	—	1.25	1.8	
	1574.42... 1576.42	MHz	—	1.25	1.8	
	1597.55... 1605.89	MHz	—	1.55	1.9	
@ output port	1559.052... 1563.144	MHz	—	1.5	1.9	
	1573.42... 1575.50	MHz	—	1.25	1.8	
	1574.42... 1576.42	MHz	—	1.25	1.8	
	1597.55... 1605.89	MHz	—	1.55	1.9	
Group delay ripple[1] (p-p)	$\Delta\tau$					
	1597.55... 1605.89	MHz	—	3	12	ns
Minimum attenuation	α_{min}					
	10... 960	MHz	47	50	—	dB
	960... 1463	MHz	36	40	—	dB
	1710... 1785	MHz	37	39	—	dB
	1785... 1990	MHz	37	39	—	dB
	1990... 2280	MHz	35	39	—	dB
	2280... 2400	MHz	35	39	—	dB
	2400... 2500	MHz	33	38	—	dB
	2500... 2700	MHz	32	36	—	dB
	2700... 3000	MHz	28	33	—	dB
	3000... 6000	MHz	15	32	—	dB

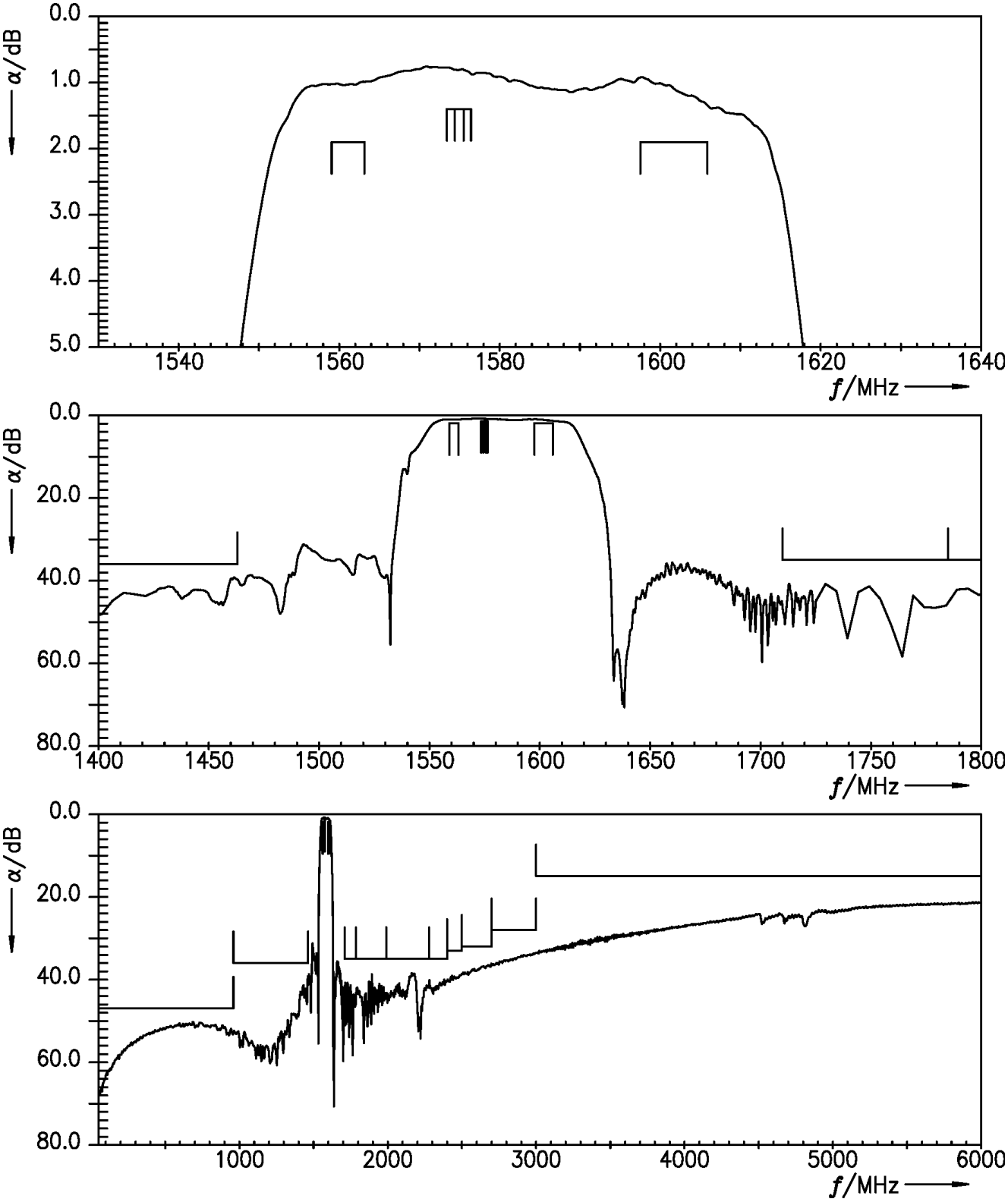
[1] Measured with an aperture of 2 MHz.

7 Maximum ratings

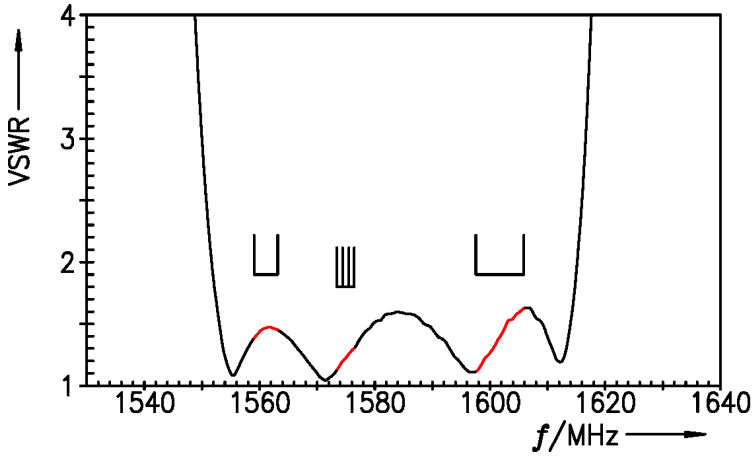
Operable temperature range	T = −30 °C ... +85 °C	
Storage temperature	T_{STG} = −40 °C ... +85 °C	
DC voltage	$\|V_{DC}\|$ = 5.0 V[1)]	
ESD voltage	V_{ESD} = 50 V[2)]	Machine model.
Input power (10000 h, 55°C)		
777 to 915 MHz	P_{IN} = 28 dBm	1/8 duty cycle, effective power in the on-state
1710 to 2200 MHz	P_{IN} = 28 dBm	1/8 duty cycle, effective power in the on-state

1) 168h Damp Heat Steady State acc. IEC 60068-2-67 Cy.
2) According to JESD22-A115B (MM – Machine Model), 10 negative & 10 positive pulses.

8 Transmission coefficient



9 Reflection coefficients



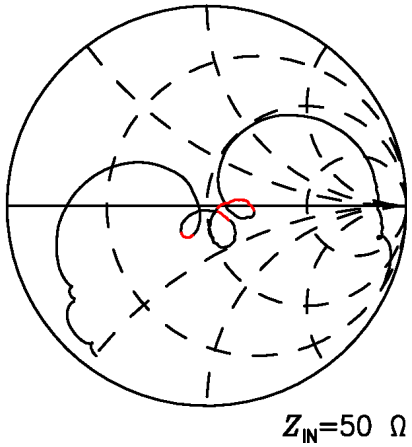
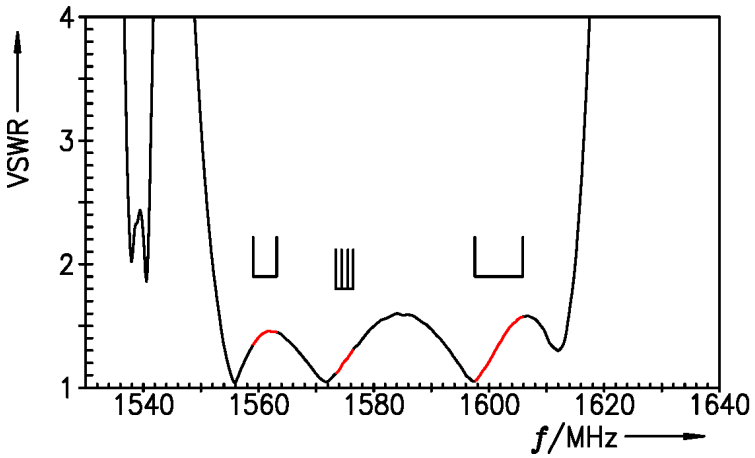


Figure 4: Reflection coefficient at IN port.



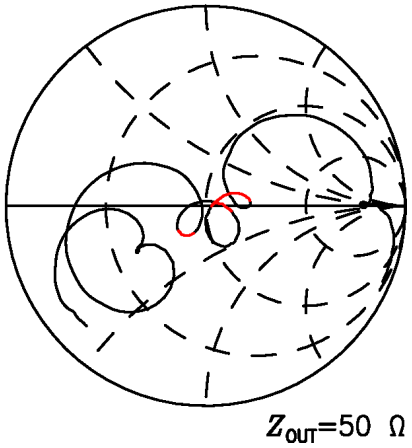


Figure 5: Reflection coefficient at OUT port.

10 Packing material

10.1 Tape

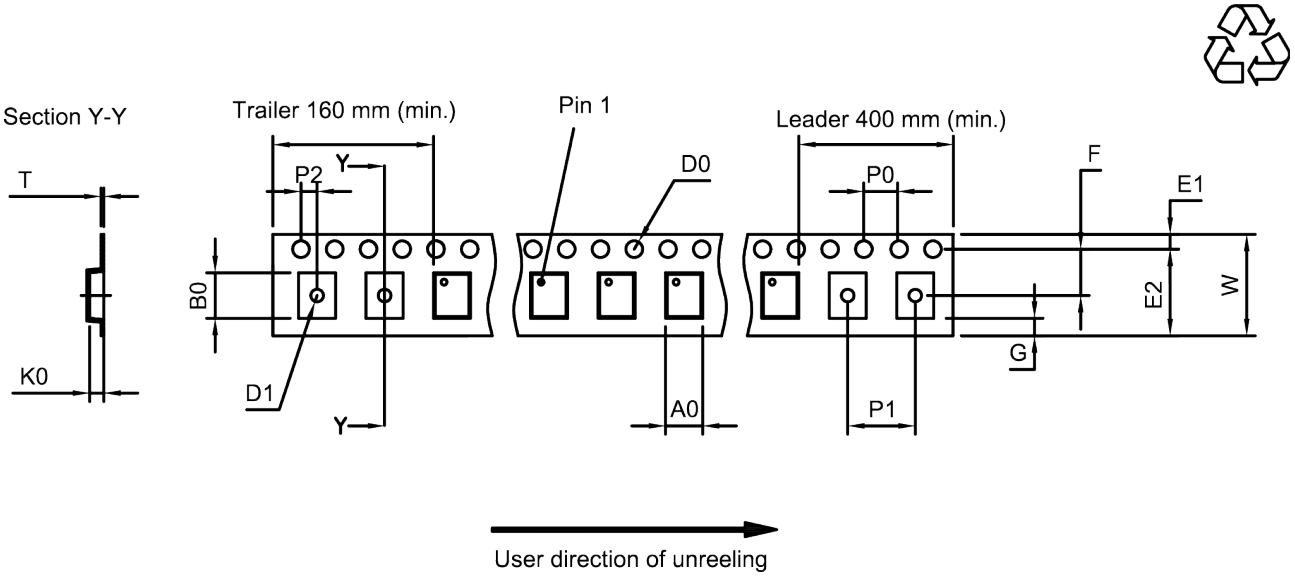


Figure 6: Drawing of tape (first-angle projection) with tape dimensions according to Table 1.

A_0	1.02±0.05 mm
B_0	1.22±0.05 mm
D_0	1.55±0.05 mm
D_1	0.55±0.1 mm
E_1	1.75±0.1 mm

E_2	6.25 mm (min.)
F	3.5±0.05 mm
G	–
K_0	0.6±0.05 mm
P_0	4.0±0.1 mm

P_1	2.0±0.1 mm
P_2	2.0±0.05 mm
T	0.25±0.03 mm
W	8.0+0.3/−0.1 mm

Table 1: Tape dimensions.

10.2 Reel with diameter of 180 mm

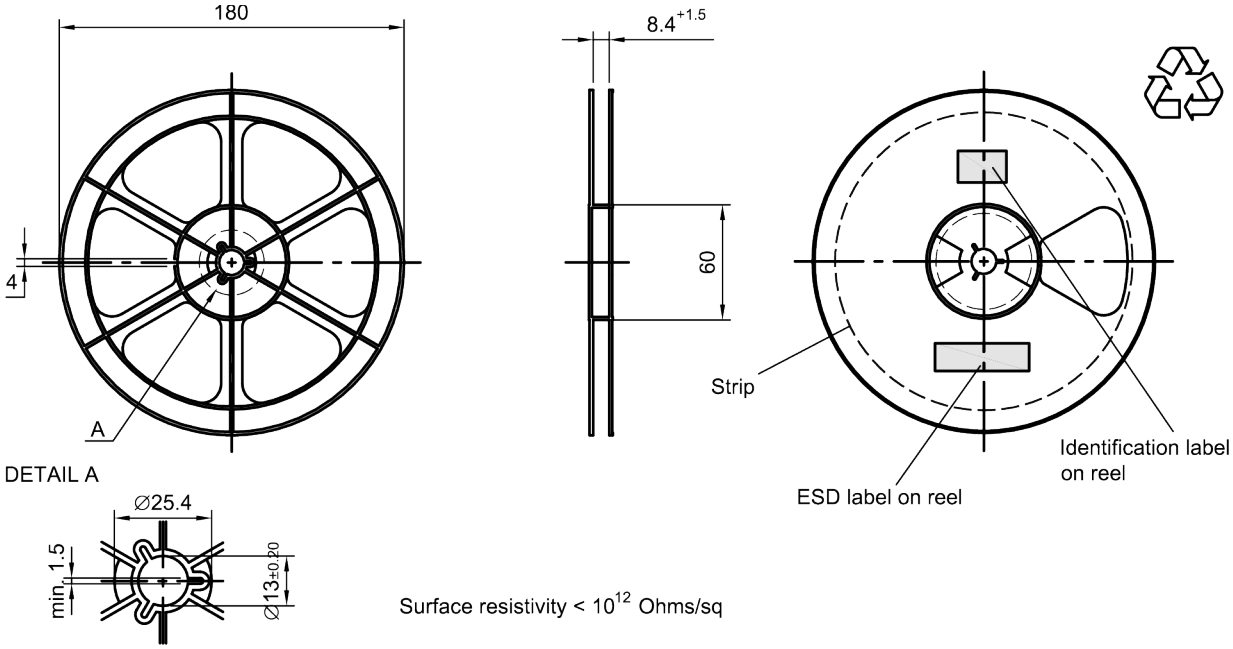


Figure 7: Drawing of reel (first-angle projection) with diameter of 180 mm.

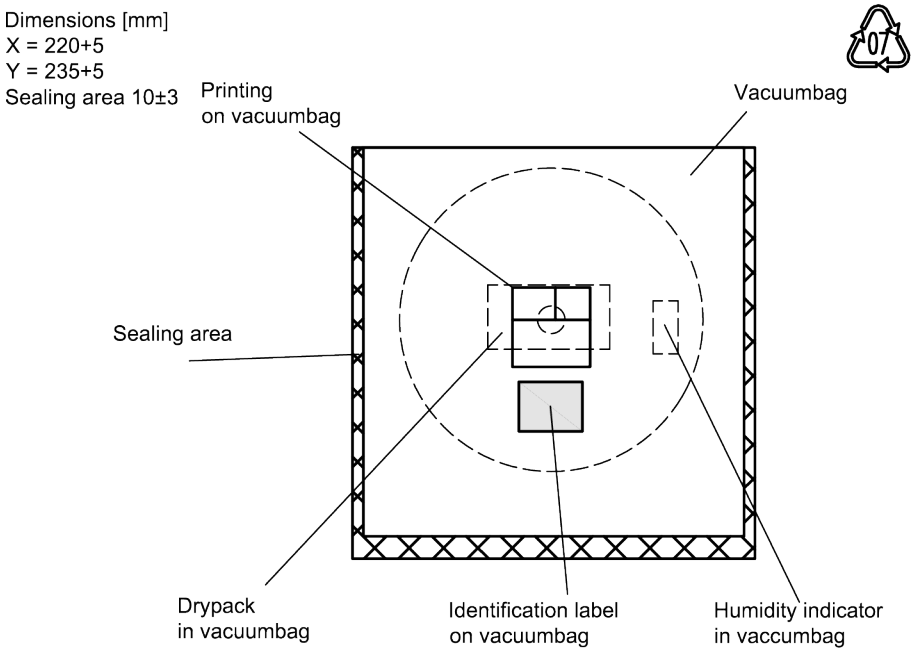


Figure 8: Drawing of moisture barrier bag (MBB) for reel with diameter of 180 mm.

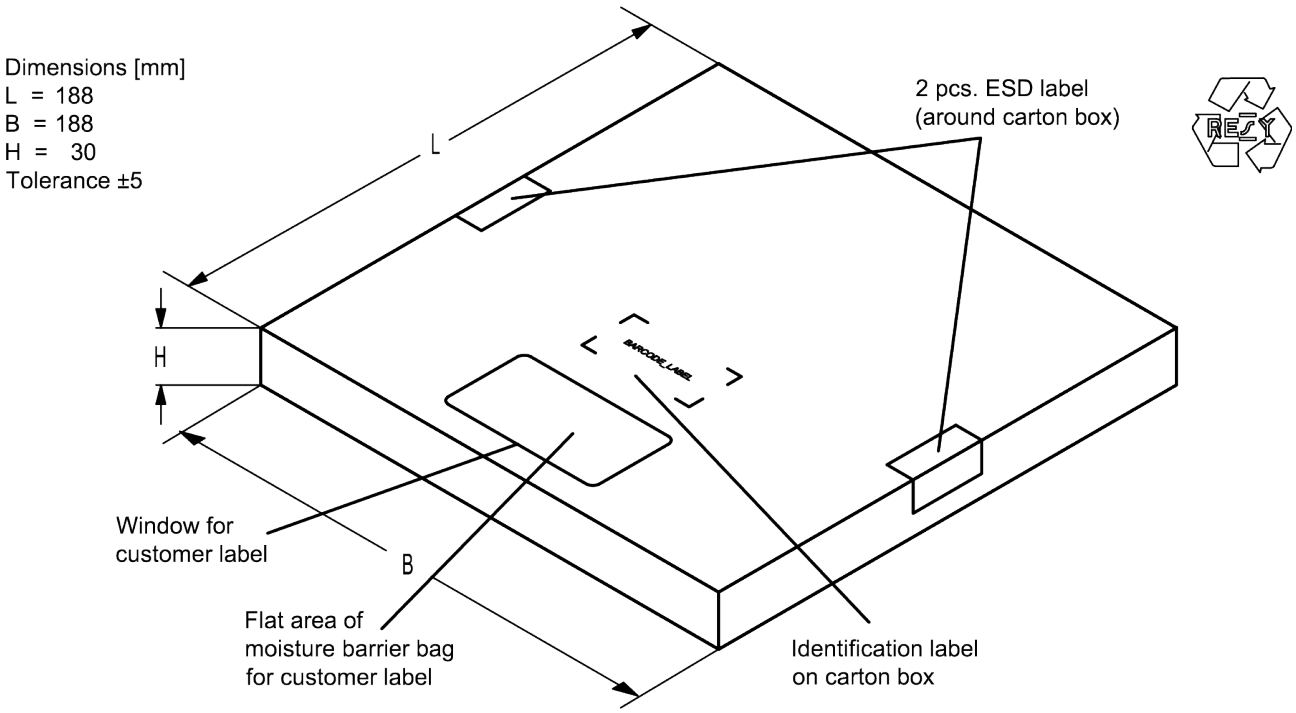


Figure 9: Drawing of folding box for reel with diameter of 180 mm.

10.3 Reel with diameter of 330 mm

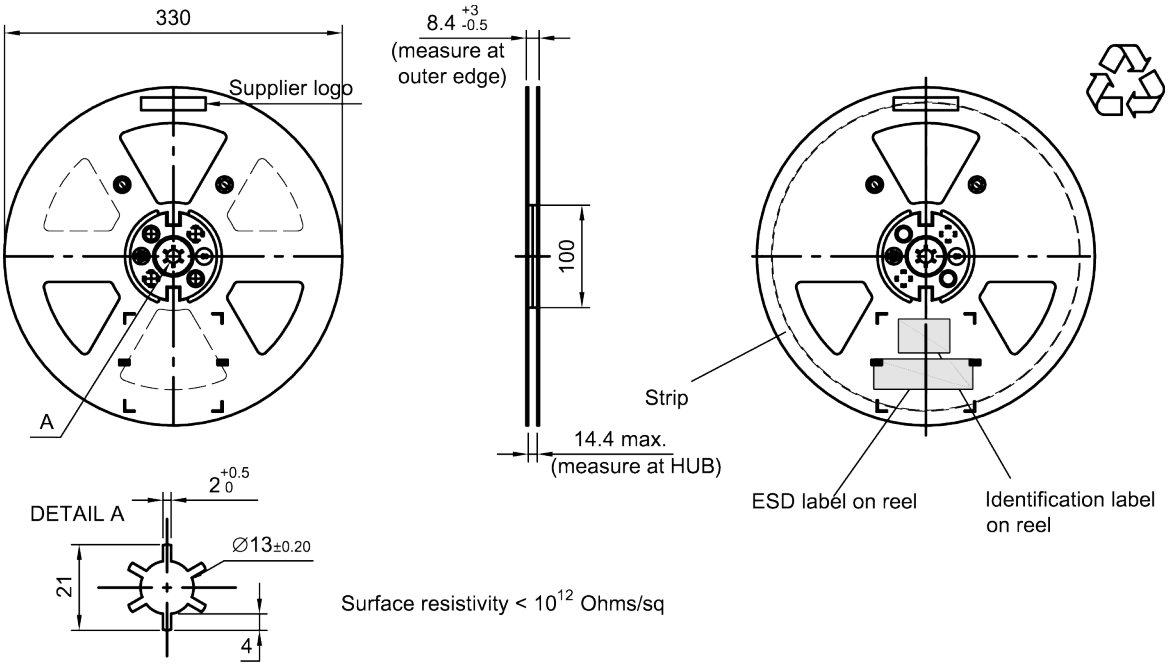


Figure 10: Drawing of reel (first-angle projection) with diameter of 330 mm.

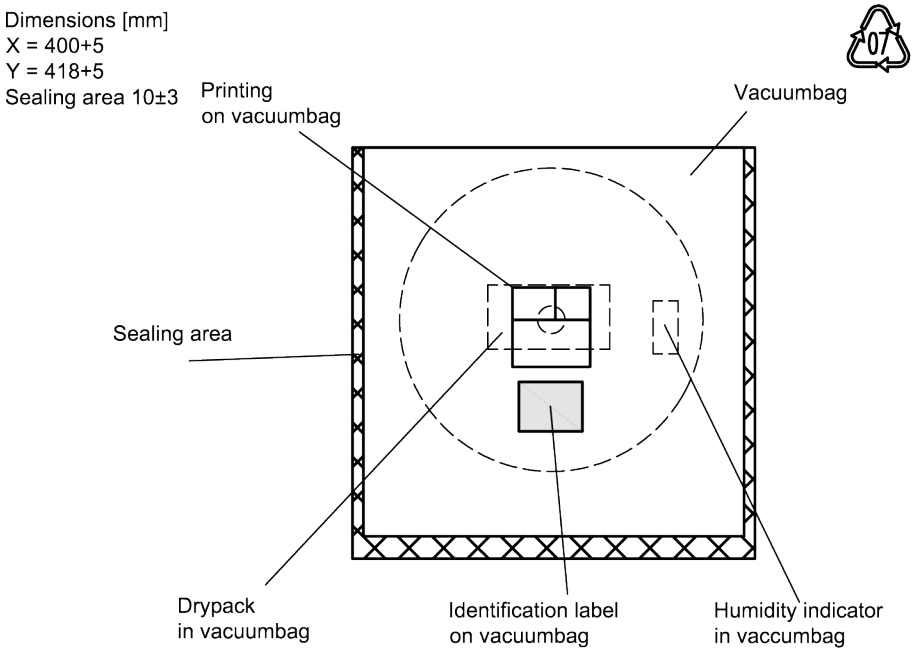


Figure 11: Drawing of moisture barrier bag (MBB) for reel with diameter of 330 mm.

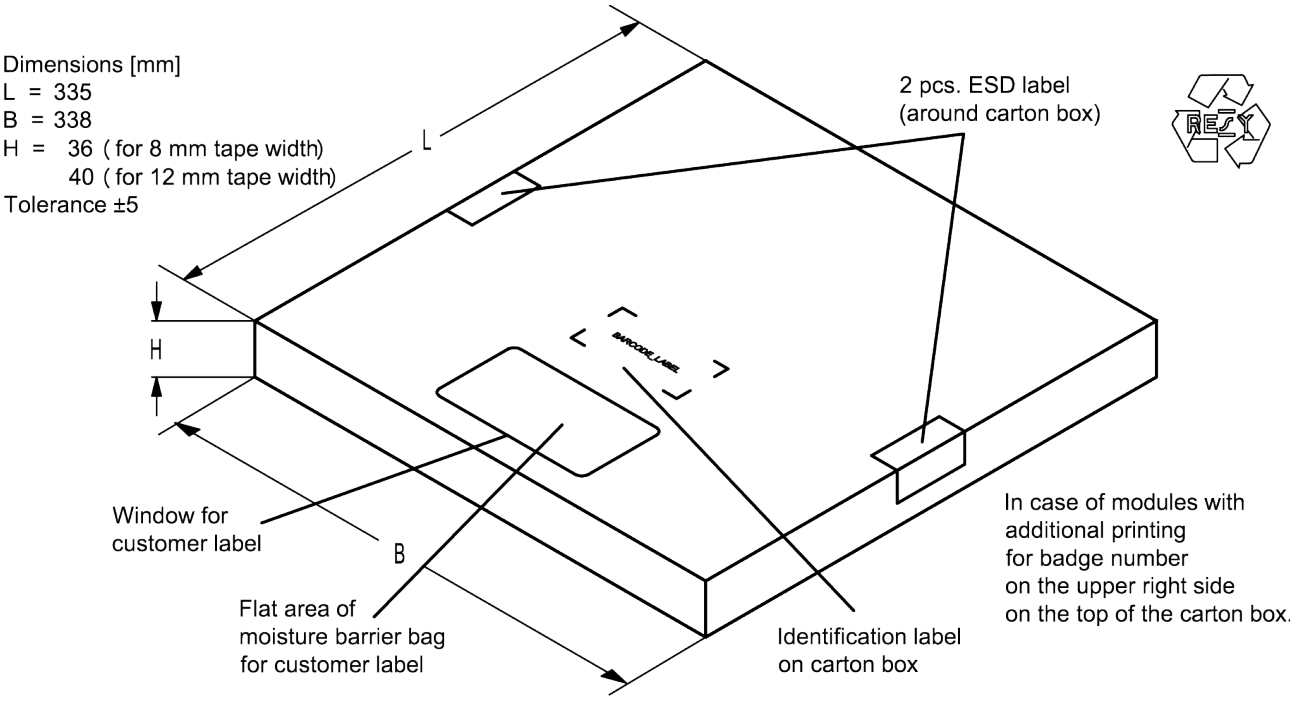


Figure 12: Drawing of folding box for reel with diameter of 330 mm.

11 Marking

Products are marked with product type number and lot number encoded according to Table 2:

- Type number:

  The 4 digit type number of the ordering code, e.g., B3xxxxB**1234**xxxx,
  is encoded by a special BASE32 code into a 3 digit marking.

  Example of decoding type number marking on device in decimal code.
  16J **=>** **1234**
  1 x 32^2 + **6** x 32^1 + **18 (=J)** x 32^0 **=** **1234**
  The BASE32 code for product type B8813 is 8KD.

- Lot number:

  The last 5 digits of the lot number, e.g., **12345**,
  are encoded based on a special BASE47 code into a 3 digit marking.

  Example of decoding lot number marking on device in decimal code.
  5UY **=>** **12345**
  5 x 47^2 + **27 (=U)** x 47^1 + **31 (=Y)** x 47^0 **=** **12345**

Adopted BASE32 code for type number			
Decimal value	Base32 code	Decimal value	Base32 code
0	0	16	G
1	1	17	H
2	2	18	J
3	3	19	K
4	4	20	M
5	5	21	N
6	6	22	P
7	7	23	Q
8	8	24	R
9	9	25	S
10	A	26	T
11	B	27	V
12	C	28	W
13	D	29	X
14	E	30	Y
15	F	31	Z

Adopted BASE47 code for lot number			
Decimal value	Base47 code	Decimal value	Base47 code
0	0	24	R
1	1	25	S
2	2	26	T
3	3	27	U
4	4	28	V
5	5	29	W
6	6	30	X
7	7	31	Y
8	8	32	Z
9	9	33	b
10	A	34	d
11	B	35	f
12	C	36	h
13	D	37	n
14	E	38	r
15	F	39	t
16	G	40	v
17	H	41	\
18	J	42	?
19	K	43	{
20	L	44	}
21	M	45	<
22	N	46	>
23	P		

Table 2: Lists for encoding and decoding of marking.

12 Soldering profile

The recommended soldering process is in accordance with IEC 60068-2-58 – 3rd edit and IPC/JEDEC J-STD-020B.

ramp rate	≤ 3 K/s
preheat	125 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s
T > 220 °C	30 s to 70 s
T > 230 °C	min. 10 s
T > 245 °C	max. 20 s
T ≥ 255 °C	–
peak temperature T_{peak}	250 °C +0/-5 °C
wetting temperature T_{min}	230 °C +5/-0 °C for 10 s ± 1 s
cooling rate	≤ 3 K/s
soldering temperature T	measured at solder pads

Table 3: Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).

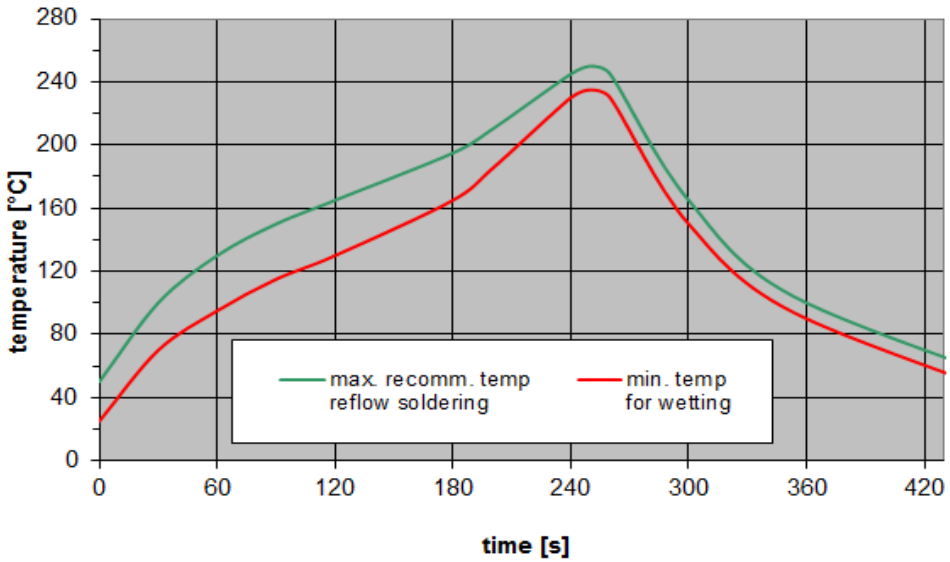


Figure 13: Recommended reflow profile for convection and infrared soldering – lead-free solder.

13 Annotations

13.1 Matching coils

See TDK inductor pdf-catalog http://www.tdk.co.jp/tefe02/coil.htm#aname1 and Data Library for circuit simulation http://www.tdk.co.jp/etvcl/index.htm.

13.2 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

13.3 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local RF360 sales office.

13.4 Ordering codes and packing units

Ordering code	Packing unit
B39162B8813P810	15000pcs
B39162B8813P810S 5	5000pcs

Table 4: Ordering codes and packing units.

14 Cautions and warnings

14.1 Display of ordering codes for RF360 products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of RF360, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under www.rf360jv.com/orderingcodes.

14.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

For information on recycling of tapes and reels please contact one of our sales offices.

14.3 Moldability

Before using in overmolding environment, please contact your local RF360 sales office.

14.4 Package information

Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on RF360 internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of RF360, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

Dimensions

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

Projection method

Unless otherwise specified first-angle projection is applied.

Important notes

The following applies to all products named in this publication:

1. Some parts of this publication contain **statements about the suitability of our products for certain areas of application**. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out **that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application.** As a rule, RF360 Europe GmbH and its affiliates are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an RF360 product with the properties described in the product specification is suitable for use in a particular customer application.
2. We also point out that **in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified.** In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
3. **The warnings, cautions and product-specific notes must be observed.**
4. In order to satisfy certain technical requirements, **some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous)**. Useful information on this will be found in our Material Data Sheets on the Internet (www.rf360jv.com/material). Should you have any more detailed questions, please contact our sales offices.
5. We constantly strive to improve our products. Consequently, **the products described in this publication may change from time to time**. The same is true of the corresponding product specifications. Please check therefore to what extent product descriptions and specifications contained in this publication are still applicable before or when you place an order. We also **reserve the right to discontinue production and delivery of products**. Consequently, we cannot guarantee that all products named in this publication will always be available.
   The aforementioned does not apply in the case of individual agreements deviating from the foregoing for customer-specific products.

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Qualcomm RF360:

B39162B8813P810